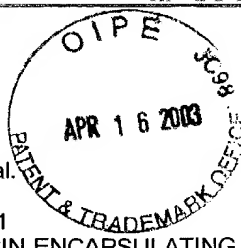


In re Application of: FUMIAKI et al.
 Application No. 09/838,161
 Filed: April 20, 2001
 For: EPOXY RESIN ENCAPSULATING SEMICONDUCTOR CHIP AND MARKED RESIN ENCAPSULATED SEMICONDUCTOR CHIP



COMMISSIONER FOR PATENTS
 Washington, D.C. 20231

Sir:

Transmitted herewith is a response to an office action in the subject application.

☐ Applicants claim small entity status of this application under 37 CFR 1.27.

☒ Petition for Extension of Time

- ☐ Applicants petition for a one-month extension of time under 37 CFR 1.136, the fee for which is \$110.00 (enclosed).
☒ Applicants believe that no petition for an extension of time is necessary. However, to the extent that such petition is deemed necessary, Applicants hereby petition for a sufficient extension of time to render the present submission timely. Please charge Deposit Account No. 12-1216 for the appropriate petition fee.

☒ No additional claim fee is required.

☐ Other:

The claim fee has been calculated as shown below:

THIS CLAIM FEE HAS BEEN CALCULATED AS SHOWN BELOW:

					SMALL ENTITY		OTHER THAN A SMALL ENTITY		
		CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	EXTRA CLAIMS PRESENT	RATE	ADDIT. CLAIM FEE	RATE	ADDIT. CLAIM FEE
TOTAL			MINUS		=	x 9=	\$	x 18=	\$
INDEPENDENT			MINUS		=	x 42=	\$	x 84=	\$
<input type="checkbox"/>	FIRST PRESENTATION OF MULTIPLE CLAIM					+ 140=	\$	+ 280=	\$
						TOTAL	\$	TOTAL	\$

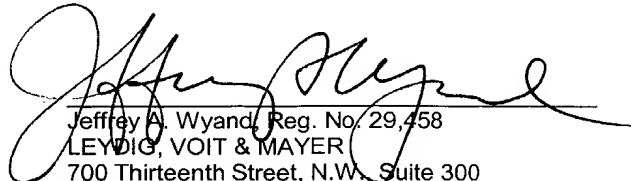
☐ Please charge my Deposit Account No. 12-1216 in the amount of \$. A duplicate copy of this sheet is attached.

☐ A check in the amount of \$ is attached.

☒ The Commissioner is hereby authorized to charge any deficiencies in the following fees associated with this communication or credit any overpayment to Deposit Account No. 12-1216. A duplicate copy of this sheet is attached.

- ☒ Any filing fees under 37 CFR 1.16 for the presentation of extra claims.
☒ Any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,


 Jeffrey A. Wyand, Reg. No. 29,458
 LEYDIG, VOIT & MAYER
 700 Thirteenth Street, N.W., Suite 300
 Washington, DC 20005-3960
 (202) 737-6770 (telephone)
 (202) 737-6776 (facsimile)

Date: April 16, 2003
 JAY:ves



**RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2827**

PATENT
Attorney Docket No. 401171/FUKAMI

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

FUMIAKI AGA

Application No. 09/838,161

Filed: April 20, 2001

For: EPOXY RESIN ENCAPSULATING
SEMICONDUCTOR CHIP AND
MARKED RESIN ENCAPSULATED
SEMICONDUCTOR CHIP

Art Unit: 2827

Examiner: L. Cruz

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RESPONSE TO OFFICE ACTION

Commissioner for Patents
Box AF
Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated January 28, 2003, please enter the following amendments and consider the following remarks.